

STPS3H100

Power Schottky rectifier

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche capability specified

Description

These Schottky rectifiers are designed for high frequency miniature switched mode power supplies such as adaptators and on board DC/DC converters. They are available in SMB, and low-profile SMB.

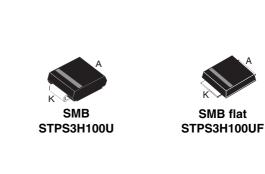


Table 1.Device summary

Symbol	Value
I _{F(AV)}	3 A
V _{RRM}	100 V
T _j (max)	175 °C
V _F (max)	0.68 V

1 Characteristics

Table 2.	Absolute ratings (limiting values)
----------	------------------------------------

Symbol	Pai	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage				V
1	Average forward current	SMB	$T_{L} = 115 \ ^{\circ}C \ \delta = 0.5$	3	А
^I F(AV)	Average lorward current	SMB flat	$T_{L} = 140 \ ^{\circ}C \ \delta = 0.5$	- 3	A
I _{FSM}	Surge non repetitive forward current	75	А		
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s$ $T_j = 25 \ ^{\circ}C$		2400	W	
T _{stg}	Storage temperature range				°C
Тj	Operating junction temperature ⁽¹⁾				°C

1. $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3.Thermal resistance

Symbol	Parameter	Value	Unit
Б	Junction to lead	25	°C/W
R _{th(j-l)}	SMB flat	15	0/00

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage currer		T _j = 25 °C	V V	-	-	1	μA
	neverse leakage current	$T_j = 125 \text{ °C}$ $V_R = V_{RRM}$	-	0.4	1	mA	
	T _j =	T _j = 25 °C	Ir = 6 A	-	-	0.84	
V _F ⁽²⁾	Forward voltage drop	T _j = 125 °C		-	0.63	0.68	V
VEY Forward voltage drop	Forward voltage drop	T _j = 25 °C		-	-	0.92	v
		T _j = 125 °C		-	0.71	0.76	

1. Pulse test: tp = 5 ms, δ < 2%

2. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.6 x $I_{F(AV)}$ + 0.027 ${I_F}^2_{(RMS)}$

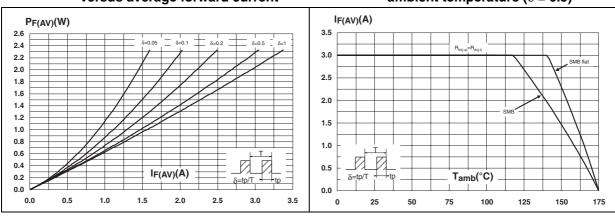
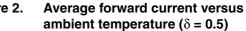


Figure 1. Average forward power dissipation Figure 2. versus average forward current



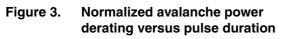


Figure 4. Normalized avalanche power derating versus junction temperature

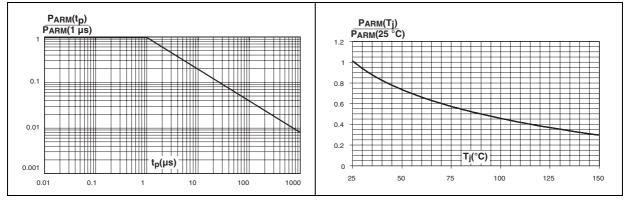
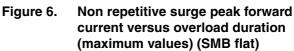


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) (SMB)



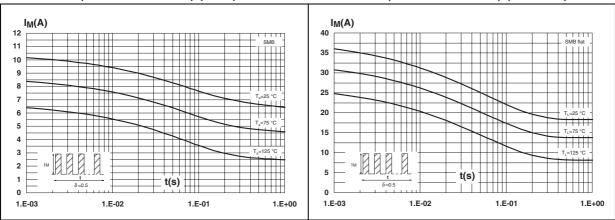
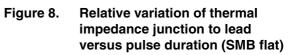


Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (SMB)



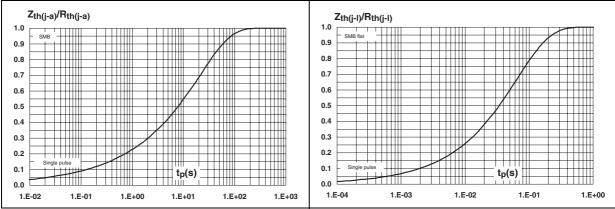
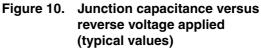


Figure 9. Reverse leakage current versus reverse voltage applied (typical values)



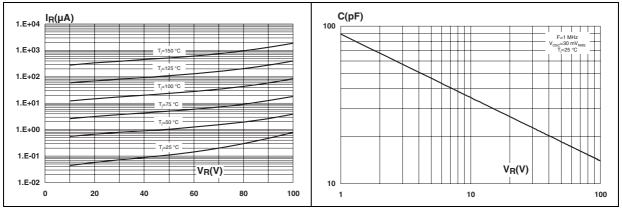
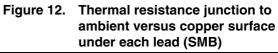




Figure 11. Forward voltage drop versus forward current



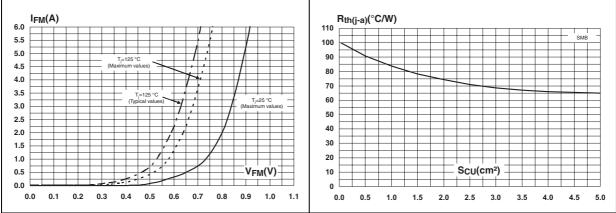
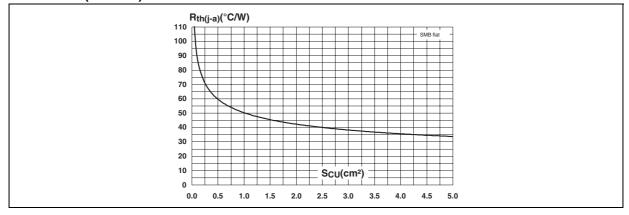


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (SMBflat)





2 Package Information

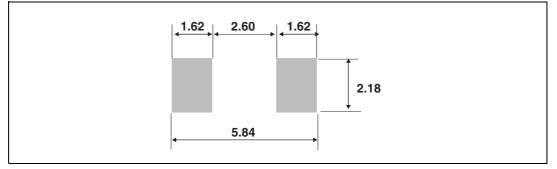
- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 5. SMB dimensions

			Dimensions				
E1	Ref		Millimeters		Inches		
		М	in.	Max.	Min.	Max.	
σ	A1	1.	.90	2.45	0.075	0.096	
	A2	0.	.05	0.20	0.002	0.008	
	b	1.	95	2.20	0.077	0.087	
	c	0.	15	0.40	0.006	0.016	
	() E	5.	10	5.60	0.201	0.220	
	Þ E1	4.	05	4.60	0.159	0.181	
	► D	3.	30	3.95	0.130	0.156	
	L	0.	75	1.50	0.030	0.059	

Figure 14. SMB footprint (dimensions in mm)



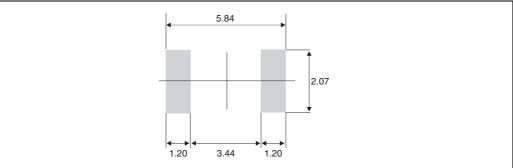


		Dimensions					
	Ref.	Millimeters		ers	Inches		
		Min.	Тур.	Max.	Min.	Тур.	Max.
C →	А	0.90		1.10	0.035		0.043
	b ⁽¹⁾	1.95		2.20	0.077		0.087
	c ⁽¹⁾	0.15		0.40	0.006		0.016
E E1	D	3.30		3.95	0.130		0.156
	Е	5.10		5.60	0.200		0.220
	E1	4.05		4.60	0.189		0.181
b	L	0.75		1.50	0.029		0.059
	L1		0.40			0.016	
	L2		0.60			0.024	

Table 6.SMBflat dimensions

1. Applies to plated leads

Figure 15. SMBflat footprint (dimensions in mm)





3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3H100U	G31	SMB	0.107 g	2500	Tape and reel
STPS3H100UF	FG31	SMBflat	0.050 g	5000	Tape and reel

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
15-Jan-2010	1	First issue.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 16776 Rev 1

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: <u>STPS3H100U</u> <u>STPS3H100UF</u>